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PATENT Mould

Attorney Docket No. SEL 174

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Shunpei Yamazaki, et al.) I hereby certify that this correspondence is being deposited with the United States Postal
Serial No.: 09/544,801) Service as first class mail in an envelope addressed to:
Filed: April 7, 2000	Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450
Examiner: Falzi Erdem) DATE: <u>June 18, 2003</u>
Art Unit: 2826) NAME: Christine A. Barglik SIGNATURE: Christine Q. Barald
For: SEMICONDUCTOR DEVICE AND METHOD FOR FABRICATING THE) SIGNATURE: Muslime U. Barylog
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Commissioner for Patents	JUN 26 20 NOLOGY CENT
P.O. Box 1450	SN E
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Dear Sir:

In response to the Office Action mailed February 18, 2003, please amend the aboveidentified patent application as follows.

In the Specification:

Please amend page 8, line 10, to read as follows:

Fig. 8A to 8C are cross-sectional views of fabrication steps for a drive circuit TFT;

Please amend page 8, line 11, to read as follows:

Fig. 9A to 9C are cross-sectional views of fabrication steps for a pixel TFT;